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Understanding Embedded - DSP (Digital Signal Processors)

Embedded - DSP (Digital Signal Processors) are specialized microprocessors designed to perform complex mathematical computations on digital signals in real-time. Unlike general-purpose processors, DSPs are optimized for high-speed numeric processing tasks, making them ideal for applications that require efficient and precise manipulation of digital data. These processors are fundamental in converting and processing signals in various forms, including audio, video, and communication signals, ensuring that data is accurately interpreted and utilized in embedded systems.

Applications of Embedded - DSP (Digital Signal Processors)

Details	
Product Status	Active
Type	Fixed Point
Interface	Host Interface, Serial Port
Clock Rate	75MHz
Non-Volatile Memory	External
On-Chip RAM	40kB
Voltage - I/O	3.30V
Voltage - Core	2.50V
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-LQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/analog-devices/adsp-2186mkstz300r

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Last Content Update: 02/23/2017

COMPARABLE PARTS

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DOCUMENTATION

Application Notes

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- AN-227: Digital Control System Design with the ADSP-2100 Family
- AN-334: Digital Signal Processing Techniques
- AN-524: ADV601/ADV611 Bin Width Calculation in ADSP-21xx DSP
- EE-06: ADSP-21xx Serial Port Startup Issues
- EE-100: ADSP-218x External Overlay Memory
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- EE-115: ADSP-2189 IDMA Interface to Motorola MC68300 Family of Microprocessors
- EE-12: Interrupts and Programmable Flags on the ADSP-2185/2186
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Data Sheet

- ADSP-2186M: 16-Bit, 75 MIPS, 2.5V, 2 Serial Ports, Host Port, 40 KB RAM Data Sheet

Evaluation Kit Manuals

- ADSP-218x DSP family and ADSP-2192 EZ-KIT Lite® Installation Procedure -Non-USB

Integrated Circuit Anomalies

- ADSP-2186M Anomaly List for Revision 2.0

Processor Manuals

- ADSP 21xx Processors: Manuals
- ADSP-218x DSP Hardware Reference
- ADSP-218x DSP Instruction Set Reference
- Using the ADSP-2100 Family Volume 1
- Using the ADSP-2100 Family Volume 2

Software Manuals

- VisualDSP++ 3.5 Assembler and Preprocessor Manual for ADSP-218x and ADSP-219x DSPs
- VisualDSP++ 3.5 C Compiler and Library Manual for ADSP-218x DSPs
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GENERAL DESCRIPTION

The ADSP-2186M is a single-chip microcomputer optimized for digital signal processing (DSP) and other high-speed numeric processing applications.

The ADSP-2186M combines the ADSP-2100 family base architecture (three computational units, data address generators, and a program sequencer) with two serial ports, a 16-bit internal DMA port, a byte DMA port, a programmable timer, Flag I/O, extensive interrupt capabilities, and on-chip program and data memory.

The ADSP-2186M integrates 40K bytes of on-chip memory configured as 8K words (24-bit) of program RAM, and 8K words (16-bit) of data RAM. Power-down circuitry is also provided to meet the low power needs of battery-operated portable equipment. The ADSP-2186M is available in a 100-lead LQFP package and 144 Ball Mini-BGA.

In addition, the ADSP-2186M supports new instructions, which include bit manipulations—bit set, bit clear, bit toggle, bit test—new ALU constants, new multiplication instruction (× squared), biased rounding, result-free ALU operations, I/O memory transfers, and global interrupt masking, for increased flexibility.

Fabricated in a high-speed, low-power, CMOS process, the ADSP-2186M operates with a 13.3 ns instruction cycle time. Every instruction can execute in a single processor cycle.

The ADSP-2186M's flexible architecture and comprehensive instruction set allow the processor to perform multiple operations in parallel. In one processor cycle, the ADSP-2186M can:

- Generate the next program address
- Fetch the next instruction
- Perform one or two data moves
- Update one or two data address pointers
- Perform a computational operation

This takes place while the processor continues to:

- Receive and transmit data through the two serial ports
- Receive and/or transmit data through the internal DMA port
- Receive and/or transmit data through the byte DMA port
- Decrement timer

DEVELOPMENT SYSTEM

The ADSP-2100 Family Development Software, a complete set of tools for software and hardware system development, supports the ADSP-2186M. The System Builder provides a high-level method for defining the architecture of systems under development. The Assembler has an algebraic syntax that is easy to program and debug. The Linker combines object files into an executable file. The Simulator provides an interactive instruction-level simulation with a reconfigurable user interface to display different portions of the hardware environment.

The EZ-KIT Lite is a hardware/software kit offering a complete evaluation environment for the ADSP-218x family: an ADSP-2189M-based evaluation board with PC monitor software plus assembler, linker, simulator, and PROM splitter software. The ADSP-2189M EZ-KIT Lite is a low cost, easy to use hardware platform on which you can quickly get started with your DSP software design. The EZ-KIT Lite includes the following features:

- 75 MHz ADSP-2189M
- Full 16-Bit Stereo Audio I/O with AD73322 Codec
- RS-232 Interface
- EZ-ICE Connector for Emulator Control
- DSP Demo Programs
- Evaluation Suite of VisualDSP

The ADSP-218x EZ-ICE® Emulator aids in the hardware debugging of an ADSP-2186M system. The ADSP-2186M integrates on-chip emulation support with a 14-pin ICE-Port interface. This interface provides a simpler target board connection that requires fewer mechanical clearance considerations than other ADSP-2100 Family EZ-ICEs. The ADSP-2186M device need not be removed from the target system when using the EZ-ICE, nor are any adapters needed. Due to the small footprint of the EZ-ICE connector, emulation can be supported in final board designs.

The EZ-ICE performs a full range of functions, including:

- In-target operation
- Up to 20 breakpoints
- Single-step or full-speed operation
- Registers and memory values can be examined and altered
- PC upload and download functions
- Instruction-level emulation of program booting and execution
- Complete assembly and disassembly of instructions
- C source-level debugging

See *Designing An EZ-ICE-Compatible Target System* in the *ADSP-2100 Family EZ-Tools Manual* (ADSP-2181 sections) as well as the Designing an EZ-ICE-Compatible System section of this data sheet for the exact specifications of the EZ-ICE target board connector.

Additional Information

This data sheet provides a general overview of ADSP-2186M functionality. For additional information on the architecture and instruction set of the processor, refer to the *ADSP-2100 Family User's Manual*. For more information about the development tools, refer to the ADSP-2100 Family Development Tools data sheet.

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external buses with bus request/grant signals ($\overline{BR}$, $\overline{BGH}$, and $\overline{BG}$). One execution mode (Go Mode) allows the ADSP-2186M to continue running from on-chip memory. Normal execution mode requires the processor to halt while buses are granted.

The ADSP-2186M can respond to eleven interrupts. There can be up to six external interrupts (one edge-sensitive, two level-sensitive, and three configurable) and seven internal interrupts generated by the timer, the serial ports (SPORTs), the Byte DMA port, and the power-down circuitry. There is also a master $\overline{RESET}$ signal. The two serial ports provide a complete synchronous serial interface with optional companding in hardware and a wide variety of framed or frameless data transmit and receive modes of operation.

Each port can generate an internal programmable serial clock or accept an external serial clock.

The ADSP-2186M provides up to 13 general-purpose flag pins. The data input and output pins on SPORT1 can be alternatively configured as an input flag and an output flag. In addition, eight flags are programmable as inputs or outputs, and three flags are always outputs.

A programmable interval timer generates periodic interrupts. A 16-bit count register (TCOUNT) decrements every n processor cycle, where n is a scaling value stored in an 8-bit register (TSCALE). When the value of the count register reaches zero, an interrupt is generated and the count register is reloaded from a 16-bit period register (TPERIOD).

Serial Ports

The ADSP-2186M incorporates two complete synchronous serial ports (SPORT0 and SPORT1) for serial communications and multiprocessor communication.

Here is a brief list of the capabilities of the ADSP-2186M SPORTs. For additional information on Serial Ports, refer to the *ADSP-2100 Family User's Manual.*

- SPORTs are bidirectional and have a separate, double-buffered transmit and receive section.
- SPORTs can use an external serial clock or generate their own serial clock internally.
- SPORTs have independent framing for the receive and transmit sections. Sections run in a frameless mode or with frame synchronization signals internally or externally generated. Frame sync signals are active high or inverted, with either of two pulsewidths and timings.
- SPORTs support serial data word lengths from 3 to 16 bits and provide optional A-law and μ-law companding according to CCITT recommendation G.711.
- SPORT receive and transmit sections can generate unique interrupts on completing a data word transfer.
- SPORTs can receive and transmit an entire circular buffer of data with only one overhead cycle per data word. An interrupt is generated after a data buffer transfer.
- SPORT0 has a multichannel interface to selectively receive and transmit a 24 or 32 word, time- division multiplexed, serial bitstream.
- SPORT1 can be configured to have two external interrupts ($\overline{IRQ0}$ and $\overline{IRQ1}$) and the FI and FO signals. The internally generated serial clock may still be used in this configuration.

PIN DESCRIPTIONS

The ADSP-2186M is available in a 100-lead LQFP package and a 144-Ball Mini-BGA package. In order to maintain maximum functionality and reduce package size and pin count, some serial port, programmable flag, interrupt and external bus pins have dual, multiplexed functionality. The external bus pins are configured during $\overline{RESET}$ only, while serial port pins are software configurable during program execution. Flag and interrupt functionality is retained concurrently on multiplexed pins. In cases where pin functionality is reconfigurable, the default state is shown in plain text; alternate functionality is shown in italics.

Common-Mode Pins

Pin Name	# of Pins	I/O	Function
$\overline{\text{RESET}}$	1	I	Processor Reset Input
$\overline{\text{BR}}$	1	I	Bus Request Input
$\overline{\text{BG}}$	1	O	Bus Grant Output
$\overline{\text{BGH}}$	1	O	Bus Grant Hung Output
$\overline{\text{DMS}}$	1	O	Data Memory Select Output
$\overline{\text{PMS}}$	1	O	Program Memory Select Output
$\overline{\text{IOMS}}$	1	O	Memory Select Output
$\overline{\text{BMS}}$	1	O	Byte Memory Select Output
$\overline{\text{CMS}}$	1	O	Combined Memory Select Output
$\overline{\text{RD}}$	1	O	Memory Read Enable Output
$\overline{\text{WR}}$	1	O	Memory Write Enable Output
$\overline{\text{IRQ2}}$ *PF7*	1	I I/O	Edge- or Level-Sensitive Interrupt Request[1] Programmable I/O Pin
$\overline{\text{IRQL1}}$ *PF6*	1	I I/O	Level-Sensitive Interrupt Requests[1] Programmable I/O Pin
$\overline{\text{IRQL0}}$ *PF5*	1	I I/O	Level-Sensitive Interrupt Requests[1] Programmable I/O Pin
$\overline{\text{IRQE}}$ *PF4*	1	I I/O	Edge-Sensitive Interrupt Requests[1] Programmable I/O Pin
Mode D *PF3*	1	I I/O	Mode Select Input—Checked Only During $\overline{\text{RESET}}$ Programmable I/O Pin During Normal Operation
Mode C *PF2*	1	I I/O	Mode Select Input—Checked Only During $\overline{\text{RESET}}$ Programmable I/O Pin During Normal Operation
Mode B *PF1*	1	I I/O	Mode Select Input—Checked Only During $\overline{\text{RESET}}$ Programmable I/O Pin During Normal Operation
Mode A *PF0*	1	I I/O	Mode Select Input—Checked Only During $\overline{\text{RESET}}$ Programmable I/O Pin During Normal Operation
CLKIN, XTAL	2	I	Clock or Quartz Crystal Input
CLKOUT	1	O	Processor Clock Output
SPORT0	5	I/O	Serial Port I/O Pins
SPORT1 $\overline{\text{IRQ1:0}}$, FI, FO	5	I/O	Serial Port I/O Pins Edge- or Level-Sensitive Interrupts, FI, FO[2]
$\overline{\text{PWD}}$	1	I	Power-Down Control Input
PWDACK	1	O	Power-Down Control Output
FL0, FL1, FL2	3	O	Output Flags
V_{DDINT}	2	I	Internal V_{DD} (2.5 V) Power (LQFP)
V_{DDEXT}	4	I	External V_{DD} (2.5 V or 3.3 V) Power (LQFP)
GND	10	I	Ground (LQFP)
V_{DDINT}	4	I	Internal V_{DD} (2.5 V) Power (Mini-BGA)
V_{DDEXT}	7	I	External V_{DD} (2.5 V or 3.3 V) Power (Mini-BGA)
GND	20	I	Ground (Mini-BGA)
EZ-Port	9	I/O	For Emulation Use

NOTES
[1]Interrupt/Flag pins retain both functions concurrently. If IMASK is set to enable the corresponding interrupts, then the DSP will vector to the appropriate interrupt vector address when the pin is asserted, either by external devices, or set as a programmable flag.
[2]SPORT configuration determined by the DSP System Control Register. Software configurable.

Memory Interface Pins

The ADSP-2186M processor can be used in one of two modes: Full Memory Mode, which allows BDMA operation with full external overlay memory and I/O capability, or Host Mode, which allows IDMA operation with limited external addressing capabilities. The operating mode is determined by the state of the Mode C pin during $\overline{\text{RESET}}$ and cannot be changed while the processor is running.

The following tables list the active signals at specific pins of the DSP during either of the two operating modes (Full Memory or Host). A signal in one table shares a pin with a signal from the other table, with the active signal determined by the mode set. For the shared pins and their alternate signals (e.g., A4/IAD3), refer to the package pinout tables.

Full Memory Mode Pins (Mode C = 0)

Pin Name	# of Pins	I/O	Function
A13:0	14	O	Address Output Pins for Program, Data, Byte, and I/O Spaces
D23:0	24	I/O	Data I/O Pins for Program, Data, Byte, and I/O Spaces (8 MSBs are also used as Byte Memory Addresses.)

Host Mode Pins (Mode C = 1)

Pin Name	# of Pins	I/O	Function
IAD15:0	16	I/O	IDMA Port Address/Data Bus
A0	1	O	Address Pin for External I/O, Program, Data, or Byte Access[1]
D23:8	16	I/O	Data I/O Pins for Program, Data, Byte, and I/O Spaces
$\overline{\text{IWR}}$	1	I	IDMA Write Enable
$\overline{\text{IRD}}$	1	I	IDMA Read Enable
IAL	1	I	IDMA Address Latch Pin
$\overline{\text{IS}}$	1	I	IDMA Select
$\overline{\text{IACK}}$	1	O	IDMA Port Acknowledge Configurable in Mode D; Open Drain

NOTE

[1]In Host Mode, external peripheral addresses can be decoded using the A0, $\overline{\text{CMS}}$, $\overline{\text{PMS}}$, $\overline{\text{DMS}}$, and $\overline{\text{IOMS}}$ signals.

The BDMA overlay bits specify the OVLAY memory blocks to be accessed for internal memory. For ADSP-2186M, set to zero BDMA overlay bits in BDMA control register.

The BMWAIT field, which has four bits on ADSP-2186M, allows selection of up to 15 wait states for BDMA transfers.

Internal Memory DMA Port (IDMA Port; Host Memory Mode)

The IDMA Port provides an efficient means of communication between a host system and the ADSP-2186M. The port is used to access the on-chip program memory and data memory of the DSP with only one DSP cycle per word overhead. The IDMA port cannot, however, be used to write to the DSP's memory-mapped control registers. A typical IDMA transfer process is described as follows:

1. Host starts IDMA transfer.
2. Host checks $\overline{\text{IACK}}$ control line to see if the DSP is busy.
3. Host uses $\overline{\text{IS}}$ and IAL control lines to latch either the DMA starting address (IDMAA) or the PM/DM OVLAY selection into the DSP's IDMA control registers. If Bit 15 = 1, the value of bits 7:0 represent the IDMA overlay: bits 14:8 must be set to 0. If Bit 15 = 0, the value of Bits 13:0 represent the starting address of internal memory to be accessed and Bit 14 reflects PM or DM for access. For ADSP-2186M, IDDMOVLAY and IDPMOVLAY bits in IDMA overlay register should be set to zero.
4. Host uses $\overline{\text{IS}}$ and $\overline{\text{IRD}}$ (or $\overline{\text{IWR}}$) to read (or write) DSP internal memory (PM or DM).
5. Host checks $\overline{\text{IACK}}$ line to see if the DSP has completed the previous IDMA operation.
6. Host ends IDMA transfer.

The IDMA port has a 16-bit multiplexed address and data bus and supports 24-bit program memory. The IDMA port is completely asynchronous and can be written while the ADSP-2186M is operating at full speed.

The DSP memory address is latched and then automatically incremented after each IDMA transaction. An external device can therefore access a block of sequentially addressed memory by specifying only the starting address of the block. This increases throughput as the address does not have to be sent for each memory access.

IDMA Port access occurs in two phases. The first is the IDMA Address Latch cycle. When the acknowledge is asserted, a 14-bit address and 1-bit destination type can be driven onto the bus by an external device. The address specifies an on-chip memory location, the destination type specifies whether it is a DM or PM access. The falling edge of the IDMA address latch signal (IAL) or the missing edge of the IDMA select signal ($\overline{\text{IS}}$) latches this value into the IDMAA register.

Once the address is stored, data can be read from, or written to, the ADSP-2186M's on-chip memory. Asserting the select line ($\overline{\text{IS}}$) and the appropriate read or write line ($\overline{\text{IRD}}$ and $\overline{\text{IWR}}$ respectively) signals the ADSP-2186M that a particular transaction is required. In either case, there is a one-processor-cycle delay for synchronization. The memory access consumes one additional processor cycle.

Once an access has occurred, the latched address is automatically incremented, and another access can occur.

Through the IDMAA register, the DSP can also specify the starting address and data format for DMA operation. Asserting the IDMA port select ($\overline{\text{IS}}$) and address latch enable (IAL) directs the ADSP-2186M to write the address onto the IAD0–14 bus into the IDMA Control Register. If Bit 15 is set to 0, IDMA latches the address. If Bit 15 is set to 1, IDMA latches into the OVLAY register. This register, shown below, is memory mapped at address DM (0x3FE0). Note that the latched address (IDMAA) cannot be read back by the host. When Bit 14 in 0x3FE7 is set to 1, timing in Figure 31 applies for short reads. When Bit 14 in 0x3FE7 is set to zero, short reads use the timing shown in Figure 32. For ADSP-2186M, IDDMOVLAY and IDPMOVLAY bits in IDMA overlay register should be set to zero.

Refer to the following figures for more information on IDMA and DMA memory maps.

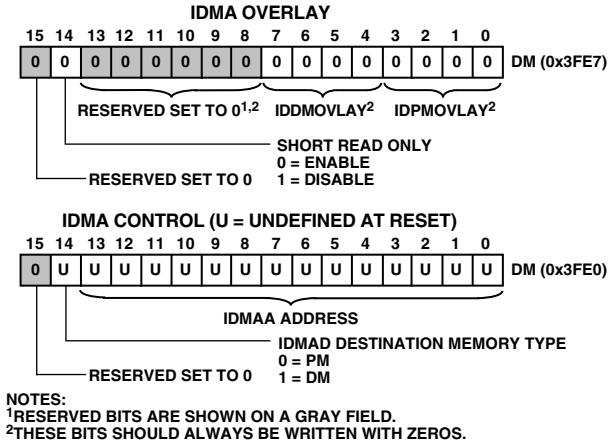
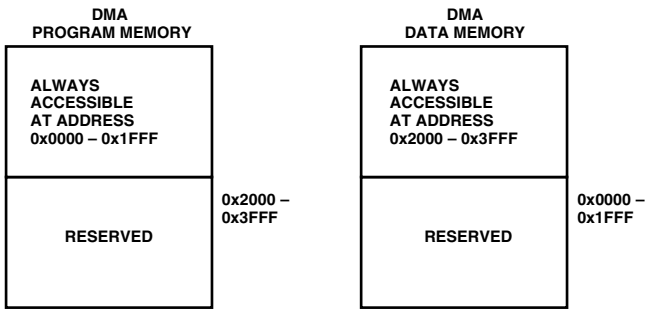


Figure 10. IDMA Control/OVLAY Registers



NOTE: IDMA AND BDMA HAVE SEPARATE DMA CONTROL REGISTERS.

Figure 11. Direct Memory Access—PM and DM Memory Maps

Bootstrap Loading (Booting)

The ADSP-2186M has two mechanisms to allow automatic loading of the internal program memory after reset. The method for booting is controlled by the Mode A, B, and C configuration bits.

When the MODE pins specify BDMA booting, the ADSP-2186M initiates a BDMA boot sequence when reset is released.

The BDMA interface is set up during reset to the following defaults when BDMA booting is specified: the BDIR, BMPAGE, BIAD, and BEAD registers are set to 0, the BTYPE register is set to 0 to specify program memory 24-bit words, and the BWCOUNT register is set to 32. This causes 32 words of on-chip program memory to be loaded from byte memory.

ADSP-2186M–SPECIFICATIONS

RECOMMENDED OPERATING CONDITIONS

Parameter	K Grade Min	K Grade Max	B Grade Min	B Grade Max	Unit
V_{DDINT}	2.37	2.63	2.25	2.75	V
V_{DDEXT}	2.37	3.6	2.25	3.6	V
V_{INPUT}[1]	V_{IL} = –0.3	V_{IH} = +3.6	V_{IL} = –0.3	V_{IH} = +3.6	V
T_{AMB}	0	+70	–40	+85	°C

NOTES

[1]The ADSP-2186M is 3.3 V tolerant (always accepts up to 3.6 V max V_{IH}), but voltage compliance (on outputs, V_{OH}) depends on the input V_{DDEXT}; because V_{OH} (max) ≈ V_{DDEXT} (max). This applies to bidirectional pins (D0–D23, RFS0, RFS1, SCLK0, SCLK1, TFS0, TFS1, A1–A13, PF0–PF7) and input only pins (CLKIN, $\overline{\text{RESET}}$, $\overline{\text{BR}}$, DR0, DR1, $\overline{\text{PWD}}$).

Specifications subject to change without notice.

ELECTRICAL CHARACTERISTICS

Parameter		Test Conditions	K/B Grades Min	Typ	Max	Unit
V_{IH}	Hi-Level Input Voltage[1, 2]	@ V_{DDINT} = max	1.5			V
V_{IH}	Hi-Level CLKIN Voltage	@ V_{DDINT} = max	2.0			V
V_{IL}	Lo-Level Input Voltage[1, 3]	@ V_{DDINT} = min			0.7	V
V_{OH}	Hi-Level Output Voltage[1, 4, 5]	@ V_{DDEXT} = min, I_{OH} = –0.5 mA	2.0			V
		@ V_{DDEXT} = 3.0 V, I_{OH} = –0.5 mA	2.4			V
		@ V_{DDEXT} = min, I_{OH} = –100 µA[6]	V_{DDEXT} – 0.3			V
V_{OL}	Lo-Level Output Voltage[1, 4, 5]	@ V_{DDEXT} = min, I_{OL} = 2 mA			0.4	V
I_{IH}	Hi-Level Input Current[3]	@ V_{DDINT} = max, V_{IN} = 3.6 V			10	µA
I_{IL}	Lo-Level Input Current[3]	@ V_{DDINT} = max, V_{IN} = 0 V			10	µA
I_{OZH}	Three-State Leakage Current[7]	@ V_{DDEXT} = max, V_{IN} = 3.6 V[8]			10	µA
I_{OZL}	Three-State Leakage Current[7]	@ V_{DDEXT} = max, V_{IN} = 0 V[8]			10	µA
I_{DD}	Supply Current (Idle)[9]	@ V_{DDINT} = 2.5, t_{CK} = 15 ns		9		mA
I_{DD}	Supply Current (Idle)[9]	@ V_{DDINT} = 2.5, t_{CK} = 13.3 ns		10		mA
I_{DD}	Supply Current (Dynamic)[10]	@ V_{DDINT} = 2.5, t_{CK} = 15 ns[11], T_{AMB} = 25°C		35		mA
I_{DD}	Supply Current (Dynamic)[10]	@ V_{DDINT} = 2.5, t_{CK} = 13.3 ns[11], T_{AMB} = 25°C		38		mA
I_{DD}	Supply Current (Power-Down)[12]	@ V_{DDINT} = 2.5, T_{AMB} = 25°C in Lowest Power Mode		100		µA
C_I	Input Pin Capacitance[3, 6]	@ V_{IN} = 2.5 V, f_{IN} = 1.0 MHz, T_{AMB} = 25°C			8	pF
C_O	Output Pin Capacitance[6, 7, 12, 13]	@ V_{IN} = 2.5 V, f_{IN} = 1.0 MHz, T_{AMB} = 25°C			8	pF

NOTES

[1] Bidirectional pins: D0–D23, RFS0, RFS1, SCLK0, SCLK1, TFS0, TFS1, A1–A13, PF0–PF7.

[2] Input only pins: $\overline{\text{RESET}}$, $\overline{\text{BR}}$, DR0, DR1, $\overline{\text{PWD}}$.

[3] Input only pins: CLKIN, $\overline{\text{RESET}}$, $\overline{\text{BR}}$, DR0, DR1, $\overline{\text{PWD}}$.

[4] Output pins: $\overline{\text{BG}}$, $\overline{\text{PMS}}$, $\overline{\text{DMS}}$, $\overline{\text{BMS}}$, $\overline{\text{IOMS}}$, $\overline{\text{CMS}}$, $\overline{\text{RD}}$, $\overline{\text{WR}}$, PWDACK, A0, DT0, DT1, CLKOUT, FL2–0, $\overline{\text{BGH}}$.

[5] Although specified for TTL outputs, all ADSP-2186M outputs are CMOS-compatible and will drive to V_{DDEXT} and GND, assuming no dc loads.

[6] Guaranteed but not tested.

[7] Three-statable pins: A0–A13, D0–D23, $\overline{\text{PMS}}$, $\overline{\text{DMS}}$, $\overline{\text{BMS}}$, $\overline{\text{IOMS}}$, $\overline{\text{CMS}}$, $\overline{\text{RD}}$, $\overline{\text{WR}}$, DT0, DT1, SCLK0, SCLK1, TFS0, TFS1, RFS0, RFS1, PF0–PF7.

[8] 0 V on $\overline{\text{BR}}$.

[9] Idle refers to ADSP-2186M state of operation during execution of IDLE instruction. Deasserted pins are driven to either V_{DD} or GND.

[10] I_{DD} measurement taken with all instructions executing from internal memory. 50% of the instructions are multifunction (Types 1, 4, 5, 12, 13, 14), 30% are Type 2 and Type 6, and 20% are idle instructions.

[11] V_{IN} = 0 V and 3 V. For typical figures for supply currents, refer to Power Dissipation section.

[12] See Chapter 9 of the *ADSP-2100 Family User's Manual* for details.

[13] Output pin capacitance is the capacitive load for any three-stated output pin.

Specifications subject to change without notice.

ABSOLUTE MAXIMUM RATINGS[1]

Parameter	Value Min	Value Max
Internal Supply Voltage (V_{DDINT})	–0.3 V	+3.0 V
External Supply Voltage (V_{DDEXT})	–0.3 V	+4.0 V
Input Voltage[2]	–0.5 V	+4.0 V
Output Voltage Swing[3]	–0.5 V	V_{DDEXT} + 0.5 V
Operating Temperature Range	–40°C	+85°C
Storage Temperature Range	–65°C	+150°C
Lead Temperature (5 sec) LQFP		280°C

NOTES
[1]Stresses greater than those listed may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions greater than those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
[2]Applies to Bidirectional pins (D0–D23, RFS0, RFS1, SCLK0, SCLK1, TFS0, TFS1, A1–A13, PF0–PF7) and Input only pins (CLKIN, $\overline{\text{RESET}}$, $\overline{\text{BR}}$, DR0, DR1, $\overline{\text{PWD}}$).
[3]Applies to Output pins ($\overline{\text{BG}}$, $\overline{\text{PMS}}$, $\overline{\text{DMS}}$, $\overline{\text{BMS}}$, $\overline{\text{IOMS}}$, $\overline{\text{CMS}}$, $\overline{\text{RD}}$, $\overline{\text{WR}}$, PWDACK, A0, DT0, DT1, CLKOUT, FL2–0, $\overline{\text{BGH}}$).

ESD SENSITIVITY

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADSP-2186M features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high-energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

TIMING SPECIFICATIONS

GENERAL NOTES

Use the exact timing information given. Do not attempt to derive parameters from the addition or subtraction of others. While addition or subtraction would yield meaningful results for an individual device, the values given in this data sheet reflect statistical variations and worst cases. Consequently, you cannot meaningfully add up parameters to derive longer times.

TIMING NOTES

Switching characteristics specify how the processor changes its signals. You have no control over this timing—circuitry external to the processor must be designed for compatibility with these signal characteristics. Switching characteristics tell you what the processor will do in a given circumstance. You can also use switching characteristics to ensure that any timing requirement of a device connected to the processor (such as memory) is satisfied.

Timing requirements apply to signals that are controlled by circuitry external to the processor, such as the data input for a read operation. Timing requirements guarantee that the processor operates correctly with other devices.

MEMORY TIMING SPECIFICATIONS

The table below shows common memory device specifications and the corresponding ADSP-2186M timing parameters, for your convenience.

Memory Device Specification	Parameter	Timing Parameter Definition[1]
Address Setup to Write Start	t_{ASW}	A0–A13, $\overline{\text{xMS}}$ Setup before $\overline{\text{WR}}$ Low
Address Setup to Write End	t_{AW}	A0–A13, $\overline{\text{xMS}}$ Setup before $\overline{\text{WR}}$ Deasserted
Address Hold Time	t_{WRA}	A0–A13, $\overline{\text{xMS}}$ Hold before $\overline{\text{WR}}$ Low
Data Setup Time	t_{DW}	Data Setup before $\overline{\text{WR}}$ High
Data Hold Time	t_{DH}	Data Hold after $\overline{\text{WR}}$ High
OE to Data Valid	t_{RDD}	$\overline{\text{RD}}$ Low to Data Valid
Address Access Time	t_{AA}	A0–A13, $\overline{\text{xMS}}$ to Data Valid

NOTE
[1]$\overline{\text{xMS}}$ = $\overline{\text{PMS}}$, $\overline{\text{DMS}}$, $\overline{\text{BMS}}$, $\overline{\text{CMS}}$ or $\overline{\text{IOMS}}$.

Parameter		Min	Max	Unit
Interrupts and Flags				
Timing Requirements:				
t_{IFS}	$\overline{IRQx}$, FI, or PFx Setup before CLKOUT Low[1, 2, 3, 4]	$0.25t_{CK}$ + 10		ns
t_{IFH}	$\overline{IRQx}$, FI, or PFx Hold after CLKOUT High[1, 2, 3, 4]	$0.25t_{CK}$		ns
Switching Characteristics:				
t_{FOH}	Flag Output Hold after CLKOUT Low[5]	$0.5t_{CK}$ – 5		ns
t_{FOD}	Flag Output Delay from CLKOUT Low[5]		$0.5t_{CK}$ + 4	ns

NOTES
[1]If $\overline{IRQx}$ and FI inputs meet t_{IFS} and t_{IFH} setup/hold requirements, they will be recognized during the current clock cycle; otherwise the signals will be recognized on the following cycle. (Refer to "Interrupt Controller Operation" in the Program Control chapter of the *ADSP-2100 Family User's Manual* for further information on interrupt servicing.)
[2]Edge-sensitive interrupts require pulsewidths greater than 10 ns; level-sensitive interrupts must be held low until serviced.
[3]$\overline{IRQx}$ = $\overline{IRQ0}$, $\overline{IRQ1}$, $\overline{IRQ2}$, $\overline{IRQL0}$, $\overline{IRQL1}$, $\overline{IRQLE}$.
[4]PFx = PF0, PF1, PF2, PF3, PF4, PF5, PF6, PF7.
[5]Flag Outputs = PFx, FL0, FL1, FL2, FO.

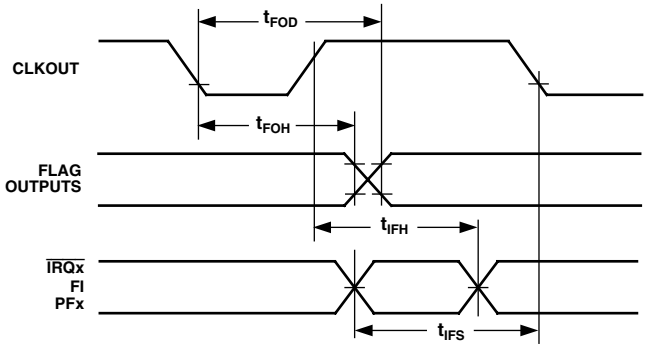


Figure 22. Interrupts and Flags

Parameter		Min	Max	Unit
Bus Request–Bus Grant				
Timing Requirements:				
t_{BH}	$\overline{BR}$ Hold after CLKOUT High[1]	$0.25t_{CK} + 2$		ns
t_{BS}	$\overline{BR}$ Setup before CLKOUT Low[1]	$0.25t_{CK} + 10$		ns
Switching Characteristics:				
t_{SD}	CLKOUT High to $\overline{xMS}$, $\overline{RD}$, $\overline{WR}$ Disable		$0.25t_{CK} + 8$	ns
t_{SDB}	$\overline{xMS}$, $\overline{RD}$, $\overline{WR}$ Disable to $\overline{BG}$ Low	0		ns
t_{SE}	$\overline{BG}$ High to $\overline{xMS}$, $\overline{RD}$, $\overline{WR}$ Enable	0		ns
t_{SEC}	$\overline{xMS}$, $\overline{RD}$, $\overline{WR}$ Enable to CLKOUT High	$0.25t_{CK} - 3$		ns
t_{SDBH}	$\overline{xMS}$, $\overline{RD}$, $\overline{WR}$ Disable to $\overline{BGH}$ Low[2]	0		ns
t_{SEH}	$\overline{BGH}$ High to $\overline{xMS}$, $\overline{RD}$, $\overline{WR}$ Enable[2]	0		ns

NOTES
$\overline{xMS}$ = $\overline{PMS}$, $\overline{DMS}$, $\overline{CMS}$, $\overline{IOMS}$, $\overline{BMS}$.
[1]$\overline{BR}$ is an asynchronous signal. If $\overline{BR}$ meets the setup/hold requirements, it will be recognized during the current clock cycle; otherwise the signal will be recognized on the following cycle. Refer to the *ADSP-2100 Family User's Manual* for $\overline{BR}$/$\overline{BG}$ cycle relationships.
[2]$\overline{BGH}$ is asserted when the bus is granted and the processor or BDMA requires control of the bus to continue.

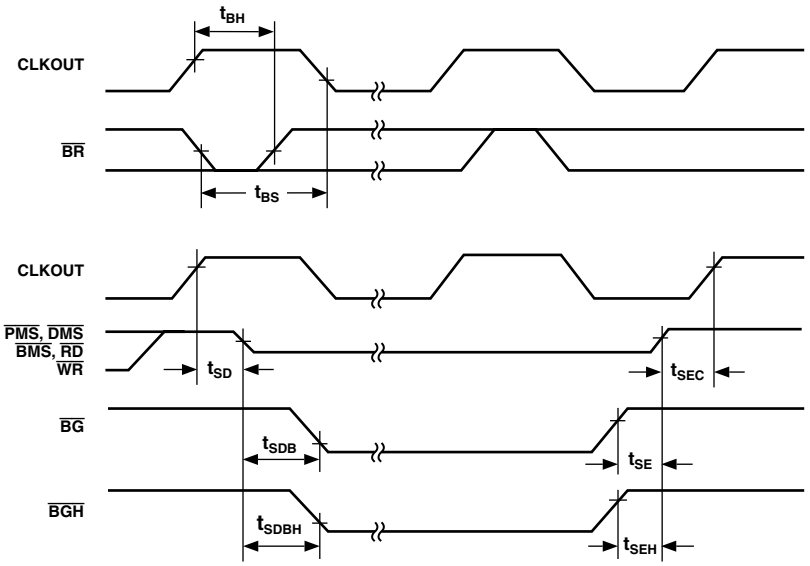


Figure 23. Bus Request–Bus Grant

Parameter		Min	Max	Unit
Memory Read				
Timing Requirements:				
t_{RDD}	$\overline{RD}$ Low to Data Valid		$0.5t_{CK} - 5 + w$	ns
t_{AA}	A0–A13, $\overline{xMS}$ to Data Valid		$0.75t_{CK} - 6 + w$	ns
t_{RDH}	Data Hold from $\overline{RD}$ High	0		ns
Switching Characteristics:				
t_{RP}	$\overline{RD}$ Pulsewidth	$0.5t_{CK} - 3 + w$		ns
t_{CRD}	CLKOUT High to $\overline{RD}$ Low	$0.25t_{CK} - 2$	$0.25t_{CK} + 4$	ns
t_{ASR}	A0–A13, $\overline{xMS}$ Setup before $\overline{RD}$ Low	$0.25t_{CK} - 3$		ns
t_{RDA}	A0–A13, $\overline{xMS}$ Hold after $\overline{RD}$ Deasserted	$0.25t_{CK} - 3$		ns
t_{RWR}	$\overline{RD}$ High to $\overline{RD}$ or $\overline{WR}$ Low	$0.5t_{CK} - 3$		ns

NOTES
w = wait states × t_{CK}.
$\overline{xMS}$ = $\overline{PMS}$, $\overline{DMS}$, $\overline{CMS}$, $\overline{IOMS}$, $\overline{BMS}$.

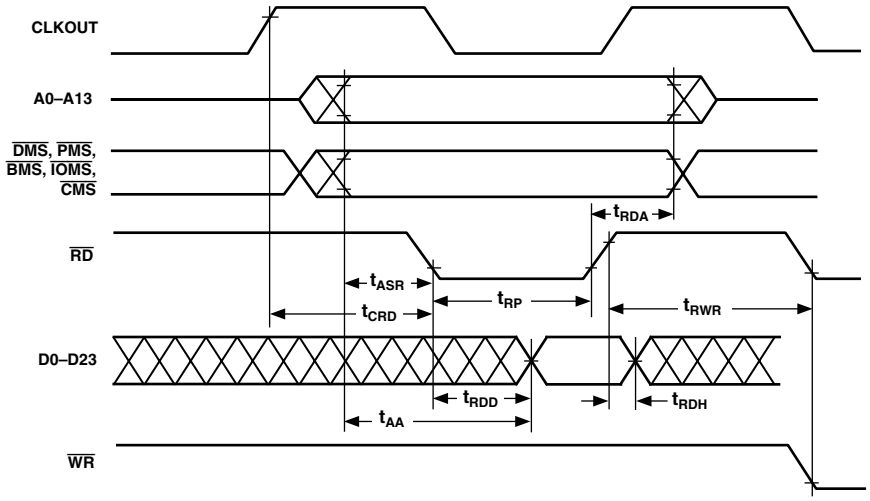


Figure 24. Memory Read

Parameter		Min	Max	Unit
IDMA Address Latch				
Timing Requirements:				
t_{IALP}	Duration of Address Latch[1, 2]	10		ns
t_{IASU}	IAD15–0 Address Setup before Address Latch End[2]	5		ns
t_{IAH}	IAD15–0 Address Hold after Address Latch End[2]	3		ns
t_{IKA}	$\overline{IACK}$ Low before Start of Address Latch[2, 3]	0		ns
t_{IALS}	Start of Write or Read after Address Latch End[2, 3]	3		ns
t_{IALD}	Address Latch Start after Address Latch End[1, 2]	2		ns

NOTES
[1]Start of Address Latch = $\overline{IS}$ Low and IAL High.
[2]End of Address Latch = $\overline{IS}$ High or IAL Low.
[3]Start of Write or Read = $\overline{IS}$ Low and $\overline{IWR}$ Low or $\overline{IRD}$ Low.

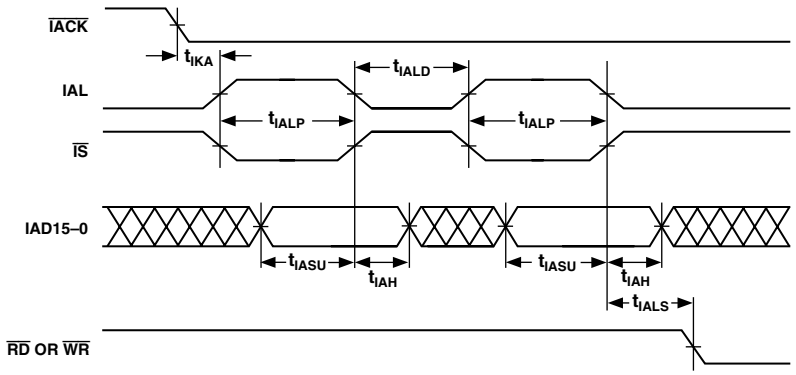


Figure 27. IDMA Address Latch

Parameter		Min	Max	Unit
IDMA Write, Short Write Cycle				
Timing Requirements:				
t_{IKW}	$\overline{IACK}$ Low before Start of Write[1]	0		ns
t_{IWP}	Duration of Write[1, 2]	10		ns
t_{IDSU}	IAD15–0 Data Setup before End of Write[2, 3, 4]	3		ns
t_{IDH}	IAD15–0 Data Hold after End of Write[2, 3, 4]	2		ns
Switching Characteristic:				
t_{IKHW}	Start of Write to $\overline{IACK}$ High		10	ns

NOTES
[1]Start of Write = $\overline{IS}$ Low and $\overline{IWR}$ Low.
[2]End of Write = $\overline{IS}$ High or $\overline{IWR}$ High.
[3]If Write Pulse ends before $\overline{IACK}$ Low, use specifications t_{IDSU}, t_{IDH}.
[4]If Write Pulse ends after $\overline{IACK}$ Low, use specifications t_{IKSU}, t_{IKH}.

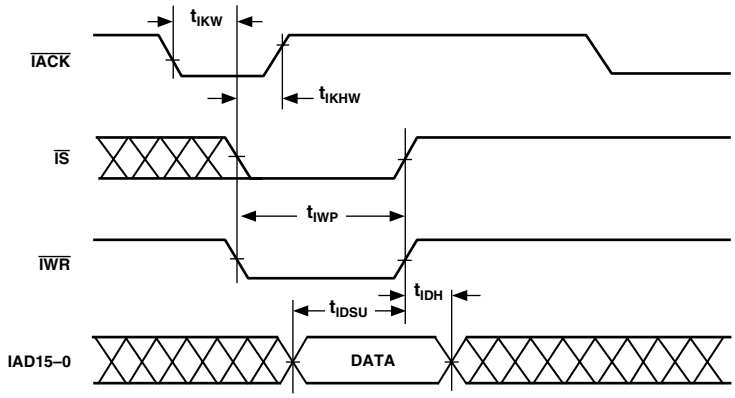


Figure 28. IDMA Write, Short Write Cycle

Parameter		Min	Max	Unit
IDMA Write, Long Write Cycle				
Timing Requirements:				
t_{IKW}	$\overline{IACK}$ Low before Start of Write[1]	0		ns
t_{IKSU}	IAD15–0 Data Setup before End of Write[2, 3, 4]	$0.5t_{CK}$ + 5		ns
t_{IKH}	IAD15–0 Data Hold after End of Write[2, 3, 4]	0		ns
Switching Characteristics:				
t_{IKLW}	Start of Write to $\overline{IACK}$ Low[4]	$1.5t_{CK}$		ns
t_{IKHW}	Start of Write to $\overline{IACK}$ High		10	ns

NOTES
[1]Start of Write = $\overline{IS}$ Low and $\overline{IWR}$ Low.
[2]If Write Pulse ends before $\overline{IACK}$ Low, use specifications t_{IDSU}, t_{IDH}.
[3]If Write Pulse ends after $\overline{IACK}$ Low, use specifications t_{IKSU}, t_{IKH}.
[4]This is the earliest time for $\overline{IACK}$ Low from Start of Write. For IDMA Write cycle relationships, please refer to the *ADSP-2100 Family User's Manual*.

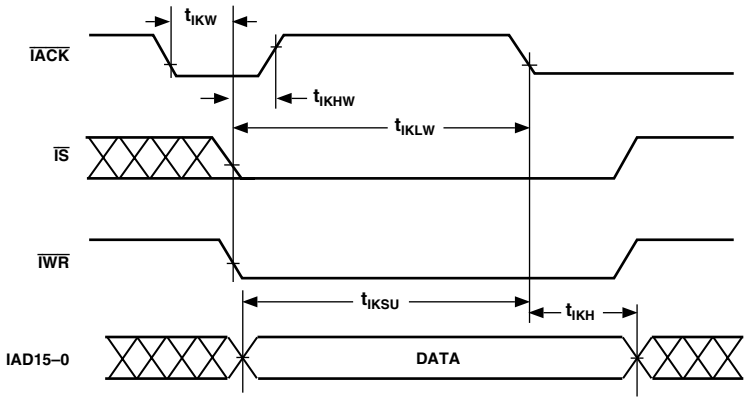


Figure 29. IDMA Write, Long Write Cycle

The LQFP package pinout is shown in the table below. Pin names in bold text replace the plain text named functions when Mode C = 1. A + sign separates two functions when either function can be active for either major I/O mode. Signals enclosed in brackets [ ] are state bits latched from the value of the pin at the deassertion of RESET.

The multiplexed pins DT1/FO, TFS1/IRQ1, RFS1/IRQ0, and DR1/FI, are mode selectable by setting Bit 10 (SPORT1 configure) of the System Control Register. If Bit 10 = 1, these pins have serial port functionality. If Bit 10 = 0, these pins are the external interrupt and flag pins. This bit is set to 1 by default upon reset.

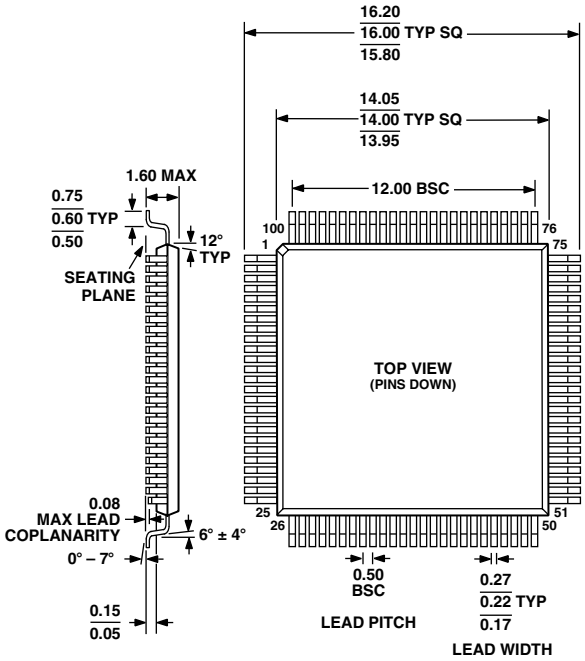
LQFP Package Pinout

Pin No.	Pin Name	Pin No.	Pin Name	Pin No.	Pin Name	Pin No.	Pin Name
1	A4/**IAD3**	26	IRQE + PF4	51	EBR	76	D16
2	A5/**IAD4**	27	IRQL0 + PF5	52	BR	77	D17
3	GND	28	GND	53	EBG	78	D18
4	A6/**IAD5**	29	IRQL1 + PF6	54	BG	79	D19
5	A7/**IAD6**	30	IRQ2 + PF7	55	D0/**IAD13**	80	GND
6	A8/**IAD7**	31	DT0	56	D1/**IAD14**	81	D20
7	A9/**IAD8**	32	TFS0	57	D2/**IAD15**	82	D21
8	A10/**IAD9**	33	RFS0	58	D3/**IACK**	83	D22
9	A11/**IAD10**	34	DR0	59	V_{DDINT}	84	D23
10	A12/**IAD11**	35	SCLK0	60	GND	85	FL2
11	A13/**IAD12**	36	V_{DDEXT}	61	D4/**IS**	86	FL1
12	GND	37	DT1/FO	62	D5/**IAL**	87	FL0
13	CLKIN	38	TFS1/IRQ1	63	D6/**IRD**	88	PF3 [MODE D]
14	XTAL	39	RFS1/IRQ0	64	D7/**IWR**	89	PF2 [MODE C]
15	V_{DDEXT}	40	DR1/FI	65	D8	90	V_{DDEXT}
16	CLKOUT	41	GND	66	GND	91	PWD
17	GND	42	SCLK1	67	V_{DDEXT}	92	GND
18	V_{DDINT}	43	ERESET	68	D9	93	PF1 [MODE B]
19	WR	44	RESET	69	D10	94	PF0 [MODE A]
20	RD	45	EMS	70	D11	95	BGH
21	BMS	46	EE	71	GND	96	PWDACK
22	DMS	47	ECLK	72	D12	97	A0
23	PMS	48	ELOUT	73	D13	98	A1/**IAD0**
24	IOMS	49	ELIN	74	D14	99	A2/**IAD1**
25	CMS	50	EINT	75	D15	100	A3/**IAD2**

OUTLINE DIMENSIONS

Dimensions shown in millimeters.

100-Lead Metric Thin Plastic Quad Flatpack (LQFP) (ST-100)

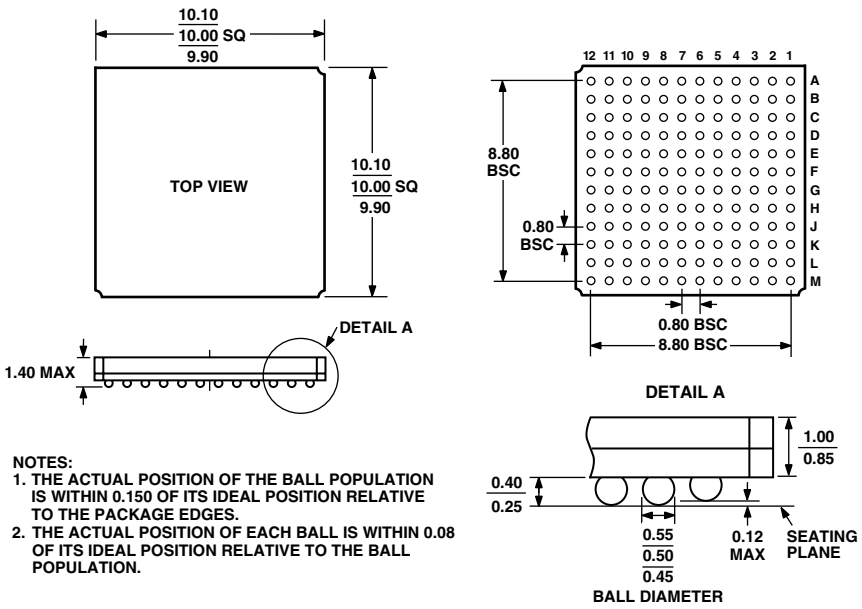


NOTE:
THE ACTUAL POSITION OF EACH LEAD IS WITHIN 0.08 FROM ITS IDEAL POSITION WHEN MEASURED IN THE LATERAL DIRECTION.

OUTLINE DIMENSIONS

Dimensions shown in millimeters.

144-Ball Mini-BGA
(CA-144)



NOTES:
1. THE ACTUAL POSITION OF THE BALL POPULATION IS WITHIN 0.150 OF ITS IDEAL POSITION RELATIVE TO THE PACKAGE EDGES.
2. THE ACTUAL POSITION OF EACH BALL IS WITHIN 0.08 OF ITS IDEAL POSITION RELATIVE TO THE BALL POPULATION.

ORDERING GUIDE

Part Number	Ambient Temperature Range	Instruction Rate	Package Description*	Package Option
ADSP-2186MKST-300	0°C to 70°C	75	100-Lead LQFP	ST-100
ADSP-2186MBST-266	–40°C to +85°C	66	100-Lead LQFP	ST-100
ADSP-2186MKCA-300	0°C to 70°C	75	144-Ball Mini-BGA	CA-144
ADSP-2186MBCA-266	–40°C to +85°C	66	144-Ball Mini-BGA	CA-144

*In 1998, JEDEC reevaluated the specifications for the TQFP package designation, assigning it to packages 1.0 mm thick. Previously labeled TQFP packages (1.6 mm thick) are now designated as LQFP.

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